





S Y B L	INCHES		N T E
	MIN.	MAX.	É
A	A	0.181	
A1	0.019	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	
A2	0.122	0.161	
b	0.014	0.022	
b2	0.045	the state	
b3	-top	0,045	
С	0.009	0.012	
D	0.355	0.382	
D <sub>1</sub>	0.005	$\prec_{\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$	
E	0.303	0.323	
E1	0.240	0.272	1
e	0.100 BSC		
еA	0.300 BSC		
eB	$\prec_{\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$	0,430	
L	0.115	0.150	

NOTES:

- 1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1982.
- 2. DIMENSIONS 'D' AND 'E1' DO NOT INCLUDE MOLD PROTRUSIONS. ALLOWABLE MOLD PROTRUSION SHALL NOT EXCEED .010" PER SIDE.
- 3. LEAD FINISH: (85±5%)Sn-Pb SOLDER PLATE
- 4. CONFORMS TO JEDEC MS-001-BA



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